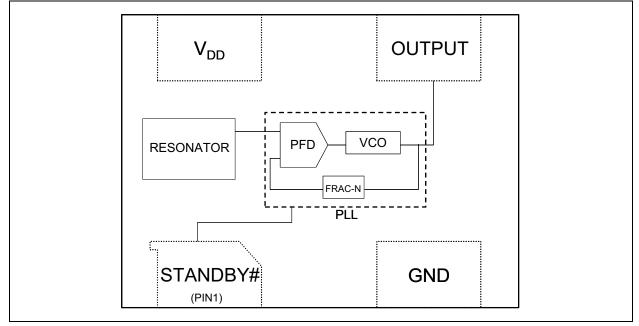
Block Diagram



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1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Input Voltage (V _{IN})	–0.3V to V _{DD} + 0.3V
ESD Protection	

Recommended Operating Conditions

 $\label{eq:supply} \begin{array}{l} \text{Supply Voltage } (V_{\text{DD}}) & \qquad +1.7 \text{V to } +3.6 \text{V} \\ \text{Output Load } (Z_{\text{L}}) & \qquad R > 10 \text{ k}\Omega, \text{ C} \leq 15 \text{ pF} \\ \hline \textbf{f} \text{ Notice: } \\ \text{Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. \\ \\ \text{This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability. \\ \end{array}$

TABLE 1-1: DC CHARACTERISTICS

Electrical Characteristics: V_{DD} = 1.8 to 3.3V; T_A = +85°C unless otherwise specified.

Parameters	Sym.	Min.	Тур.	Max.	Units	Condi	tions
Frequency	F ₀	1	_	150	MHz	Single Frequency	/
		_	_	±10		Includes frequency variations due to initial tolerance, temperature and power supply	
Francisco Talenaria	A. 5	_	_	±20			
Frequency Tolerance	Δf	_	_	±25	ppm		
		_	_	±50		voltage	
Aging	Δf	—	_	±5	ppm	1 year @ +25°C	
Supply Current, Standby	I _{DD}			15	μA	T = +25°C	
Output Startup Time (Note 1)	t _{SU}	_	1.0	1.3	ms	T = +25°C	
Output Disable Time	t _{DA}	_	20	100	ns	_	
Output Duty Cycle	SYM	45	_	55	%	—	
Input Logic Level High	V _{IH}	0.75 x V _{DD}		—	V	—	
Input Logic Level Low	V _{IL}			$0.25 \times V_{DD}$	V	—	
V _{DD} = 1.8V							
		_	6.0	6.3		1 MHz	C _L = 0 pF, R _L = ∞, T = +25°C
Supply Current No.Lond		—	6.5	7.1			
Supply Current, No Load	I _{DD}	—	7.2	8.5	mA		
		—	8.3	11.9		150 MHz	
		0.8 x V _{DD}		—		–6 mA, DSC1004	I, C _L = 40 pF
Output Logic Level High	V _{OH}	0.8 x V _{DD}		—	V	–6 mA, DSC1003	3, C _L = 25 pF
		0.8 x V _{DD}		_		-4 mA, DSC1001	l, C _L = 15 pF
		_		$0.2 \text{ x V}_{\text{DD}}$		6 mA, DSC1004,	C _L = 40 pF
Output Logic Level Low	V _{OL}			0.2 x V _{DD}	V	6 mA, DSC1003,	C _L = 25 pF
				0.2 x V _{DD}		4 mA, DSC1001,	C _L = 15 pF

Note 1: t_{SU} is time to stable output frequency after V_{DD} is applied. t_{SU} and t_{EN} (after EN is asserted) are identical values.

2: Measured over 50k clock cycles.

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TABLE 1-1: DC CHARACTERISTICS (CONTINUED)

Electrical Characteristics: V_{DD} = 1.8 to 3.3V; T_A = +85°C unless otherwise specified.

Parameters	Sym.	Min.	Тур.	Max.	Units	Cond	itions	
Output Transition Rise Time		—	1.4	3.0	ns	DSC1001, C _L = 15 pF		
	t _R	—	1.5	3.0		DSC1003, C _L = 25 pF	T = +25°C, 20% to 80%	
		—	1.8	3.0		DSC1004, C ₂ = 40 pF		
		_	1.0	3.0		DSC1001, C _L = 15 pF		
Output Transition Fall Time	t _F	_	1.1	3.0	ns	DSC1003, C _L = 25 pF	T = +25°C, 20% to 80%	
		_	1.2	3.0		DSC1004, C ₂ = 40 pF		
Jitter, Max. Cycle-to-Cycle	J ^{CC}	_	60		ps	f = 100 MHz (No	ote 2)	
Period Jitter	J _P		10	15	ps _{RMS}	f = 100 MHz (No	ote 2)	
V _{DD} = 2.5V								
	I _{DD}	—	6.0	6.4	mA	1 MHz	C _L = 0 pF, R _L = ∞, T = +25°C	
Supply Current No. Lond			6.7	7.5		27 MHz		
Supply Current, No Load		_	7.7	9.4		70 MHz		
		_	9.6	13.9		150 MHz		
	V _{OH}	0.9 x V _{DD}	_	_	V	-6 mA, DSC100	4, C _L = 40 pF	
Output Logic Level High		0.8 x V _{DD}	_	_		–6 mA, DSC1003, C _L = 25 pF		
		0.8 x V _{DD}	_	_		–4 mA, DSC1001, C _L = 15 pF		
	V _{OL}	_	_	0.1 x V _{DD}		6 mA, DSC1004, C _L = 40 pF		
Output Logic Level Low		_	_	0.2 x V _{DD}	V	6 mA, DSC1003	DSC1003, C _L = 25 pF	
		_	_	0.2 x V _{DD}		4 mA, DSC1001	, C _L = 15 pF	
		—	1.0	2.0		DSC1001, C _L = 15 pF		
Output Transition Rise Time	t _R	—	1.1	2.0	ns	DSC1003, C _L = 25 pF	T = +25°C, 20% to 80%	
		_	1.2	2.0		DSC1004, C ₂ = 40 pF		
		_	0.9	2.0	ns	DSC1001, C _L = 15 pF	T = +25°C, 20% to 80%	
Output Transition Fall Time	t _F		1.0	2.0		DSC1003, C _L = 25 pF		
		_	1.1	2.0		DSC1004, C ₂ = 40 pF		

Note 1: t_{SU} is time to stable output frequency after V_{DD} is applied. t_{SU} and t_{EN} (after EN is asserted) are identical values.

2: Measured over 50k clock cycles.

TABLE 1-1: DC CHARACTERISTICS (CONTINUED)

Parameters	Sym.	Min.	Тур.	Max.	Units	Cond	itions
Jitter, Max. Cycle-to-Cycle	J ^{CC}	_	50	_	ps	f = 100 MHz (No	te 2)
Period Jitter	J _P		5	10	ps _{RMS}	f = 100 MHz (No	te 2)
V _{DD} = 3.3V							
			6.0	6.5		1 MHz	
Supply Current No. Lood			6.8	8.0		27 MHz	C _L = 0 pF,
Supply Current, No Load	I _{DD}	_	8.2	10.5	mA	70 MHz	R _L = ∞, T = +25°C
			10.8	16.6		150 MHz	
		0.9 x V _{DD}	_			–8 mA, DSC100	4, C _L = 40 pF
Output Logic Level High	V _{OH}	0.9 x V _{DD}	_		V	–6 mA, DSC1003, C _L = 25 pF	
		0.8 x V _{DD}	_			–4 mA, DSC1001, C _L = 15 pF	
Output Logic Level Low	V _{OL}		_	0.1 x V _{DD}	V	8 mA, DSC1004, C _L = 40 pF	
		—	_	0.1 x V _{DD}		6 mA, DSC1003	, C _L = 25 pF
		—	_	$0.2 ext{ x V}_{\text{DD}}$		4 mA, DSC1001	, C _L = 15 pF
		—	1.0	2.0		DSC1001, C _L = 15 pF	T = +25°C, 20% to 80%
Output Transition Rise Time	t _R	—	1.1	2.0	ns	DSC1003, C _L = 25 pF	
		—	1.2	2.0		DSC1004, C ₂ = 40 pF	
		—	0.9	2.0		DSC1001, C _L = 15 pF	T = +25°C, 20% to 80%
Output Transition Fall Time	t _F	_	1.0	2.0	ns	DSC1003, C _L = 25 pF	
		_	1.1	2.0		DSC1004, C ₂ = 40 pF	
Jitter, Max. Cycle-to-Cycle	J ^{CC}	_	50	_	ps	f = 100 MHz (No	te 2)
Period Jitter	J_P	_	5	10	ps _{RMS}	f = 100 MHz (No	te 2)

Electrical Characteristics: V_{DD} = 1.8 to 3.3V; T_A = +85°C unless otherwise specified.

Note 1: t_{SU} is time to stable output frequency after V_{DD} is applied. t_{SU} and t_{EN} (after EN is asserted) are identical values.

2: Measured over 50k clock cycles.

TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
		-40	_	+105	°C	Ordering Option L
Operating Temperature Range (T)	T _A	-40	_	+85	°C	Ordering Option I
		-20	_	+70	°C	Ordering Option E
Junction Operating Temperature	ТJ	_	_	+150	°C	—
Storage Temperature Range	T _A	-55		+150	°C	—
Soldering Temperature Range	Τ _S	_	_	+260	°C	40 sec. max

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +150°C rating. Sustained junction temperatures above +150°C can impact the device reliability.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1 and Table 2-2.

TABLE 2-1: CDFN PACKAGE PIN FUNCTION TABLE

Pin Number	Symbol	Description
1	STANDBY#	Standby input (Section 4.1 "Standby Function")
2	GND	Power supply ground
3	OUT	Oscillator output
4	VDD	Positive power supply

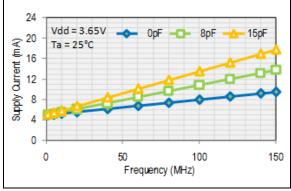
TABLE 2-2: DFN PACKAGE PIN FUNCTION TABLE

Pin Number	Symbol	Description
1	STANDBY#	Standby input (Section 4.1 "Standby Function")
2	GND	Power supply ground
3	OUT	Oscillator output
4	VDD	Positive power supply
Center Pad	NC	Tie to GND or do not connect.

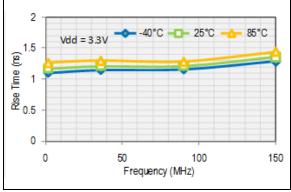
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3.0 NOMINAL PERFORMANCE CHARACTERISTICS

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.









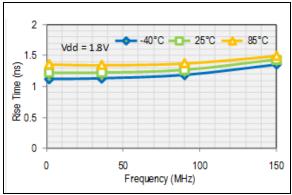
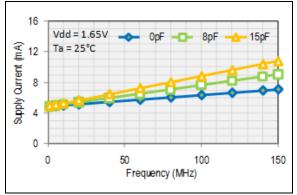
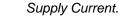
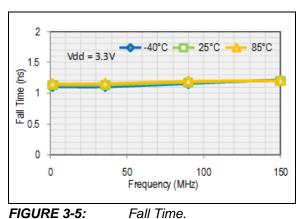


FIGURE 3-3: Rise Time.









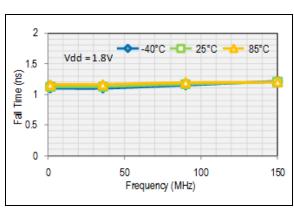


FIGURE 3-6: Fall Time.

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4.0 OUTPUT WAVEFORM

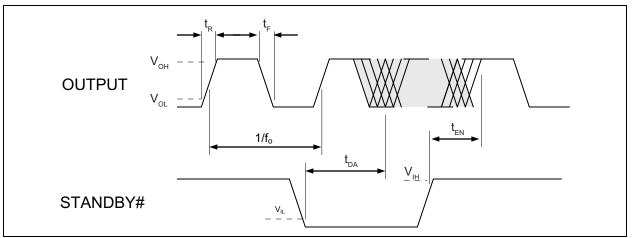


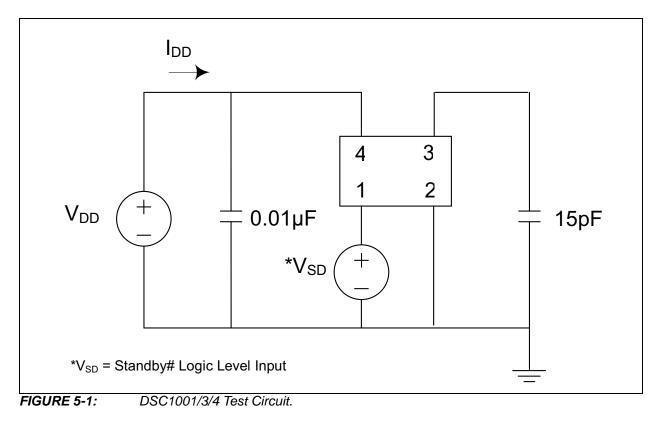
FIGURE 4-1: Output Waveform.

4.1 Standby Function

Standby# (Pin 1)	Output (Pin 3)
High Level	Output ON
Open (no connect)	Output ON
Low Level	High Impedance

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5.0 TEST CIRCUIT



6.0 BOARD LAYOUT (RECOMMENDED)

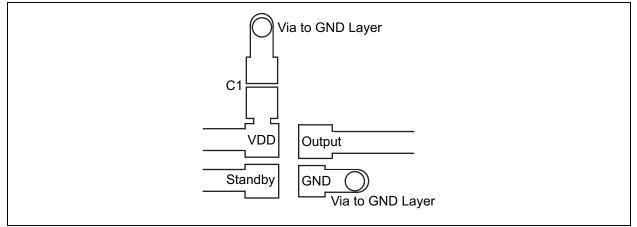


FIGURE 6-1:

Recommended Board Layout for DSC1001/3/4.

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7.0 SOLDER REFLOW PROFILE

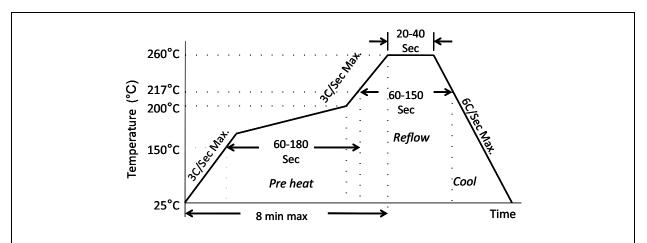
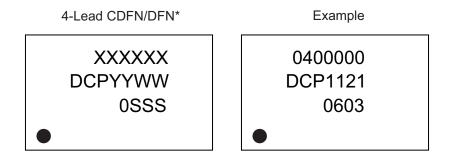


FIGURE 7-1: Solder Reflow Profile.

MSL 1 @ 260°C refer to JSTD-020C				
Ramp-Up Rate (200°C to Peak Temp)	3°C/sec. max.			
Preheat Time 150°C to 200°C	60 to 180 sec.			
Time maintained above 217°C	60 to 150 sec.			
Peak Temperature	255°C to 260°C			
Time within 5°C of Actual Peak	20 to 40 sec.			
Ramp-Down Rate	6°C/sec. max.			
Time 25°C to Peak Temperature	8 minutes max.			

8.0 PACKAGING INFORMATION

8.1 Package Marking Information

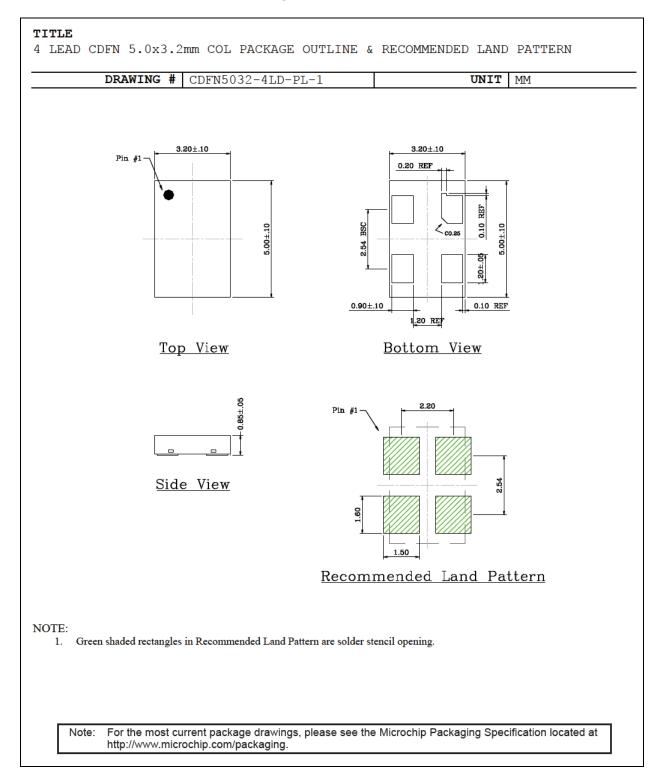


Legend	I: XXX Y YY WW NNN (€3) * •, ▲, ▼ mark).	Product code, customer-specific information, or frequency in MHz without printed decimal point Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
Note:	be carried characters the corpor	0
	Underbar	(_) and/or Overbar (¯) symbol may not be to scale.

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TITLE 4 LEAD DFN 7.0x5.0mm PACKAGE OUTLINE & RECOMMENDED LAND PATTERN UNIT MM DRAWING # DFN75-4LD-PL-1 1.20±.10 Pin #1 1.00 REF C0.25 REF 3.50±.10 .00±.10 0 BSC 7.00±.10 1.50 2.20±. 5.08 $1.40 \pm .05$ 2.60 REF 5.00±.10 5.00±.10 Bottom View Top View 2.00 0.85±.05 8 Side View 80 4.20 Recommended Land Pattern NOTE: 1. Green shaded rectangles in Recommended Land Pattern are solder stencil opening. 2. Red shaded rectangle in Recommended Land Pattern is keep out area. For the most current package drawings, please see the Microchip Packaging Specification located at Note: http://www.microchip.com/packaging.

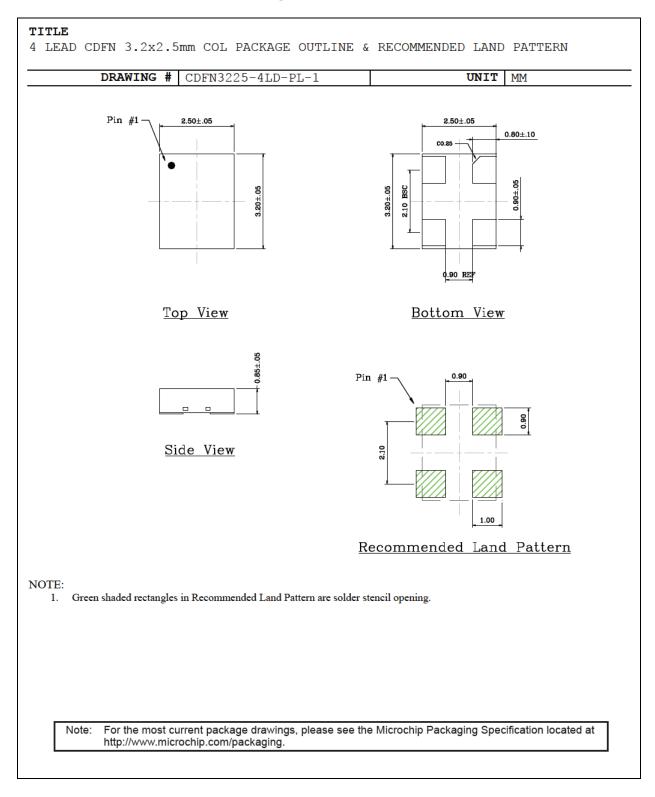
4-Lead DFN 7.0 mm x 5.0 mm Package Outline & Recommended Land Pattern

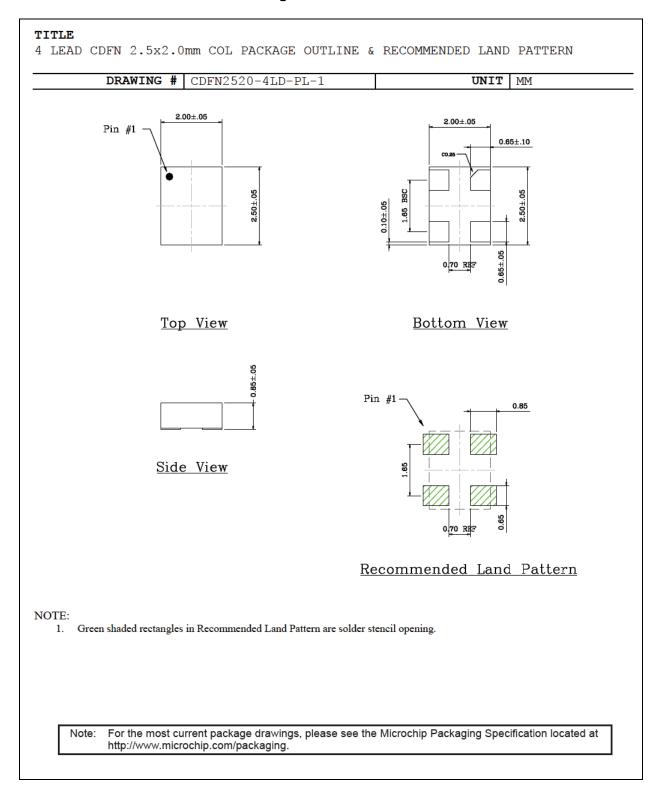


4-Lead CDFN 5.0 mm x 3.2 mm Package Outline & Recommended Land Pattern

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4-Lead CDFN 3.2 mm x 2.5 mm Package Outline & Recommended Land Pattern







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NOTES:

APPENDIX A: REVISION HISTORY

Revision A (September 2017)

- Converted Micrel data sheet DSC1001 to Microchip format data sheet DS20005529A.
- Minor text changes throughout.
- Added Table 2-2 for DFN package.
- Combined Micrel data sheet DSC1003 and DSC1004 into this data sheet.
 - Updated Section 1.0 "Electrical Characteristics" to reflect this change.
 - Updated General Description and Features to reflect this change.

Revision B (November 2017)

- Updated V_{OH} and V_{OL} values in Table 1-1.

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NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	<u>× × × -xxx.xxxx ×</u>	Examples:
Device	Package Temperature Stability Frequency Package Range DSC1001/3/4: 1.8V - 3.3V Low-Power Precision CMOS Oscillator	a) DSC1001AE1-010.0000T: 1.8V - 3.3V Low-Power Pre- cision CMOS Oscillator, 4- Lead 7.0 mm x 5.0 mm DFN, Ext. Commercial Tem- perature Range, ±50 ppm, 10 MHz Output Fre- guency, 1,000/Reel
Package:	A = 4-Lead 7.0 mm x 5.0 mm DFN B = 4-Lead 5.0 mm x 3.2 mm CDFN C = 4-Lead 3.2 mm x 2.5 mm CDFN D = 4-Lead 2.5 mm x 2.0 mm CDFN	 b) DSC1003BL2-030.0000: 1.8V - 3.3V Low-Power Precision CMOS Oscillator, 4- Lead 5.0 mm x 3.2 mm CDFN, Ext. Industrial Tem-
Temperature Range:	$ \begin{array}{rcl} E &=& -20^\circ \mathrm{C} \ \mathrm{to} \ +70^\circ \mathrm{C} \ (\mathrm{Extended} \ \mathrm{Commercial}) \\ I &=& -40^\circ \mathrm{C} \ \mathrm{to} \ +85^\circ \mathrm{C} \ (\mathrm{Industrial}) \\ L &=& -40^\circ \mathrm{C} \ \mathrm{to} \ +105^\circ \mathrm{C} \ (\mathrm{Extended} \ \mathrm{Industrial}) \end{array} $	perature Range, ±25 ppm, 30 MHz Output Fre- quency, 110/Tube c) DSC1001DE5-150.0000:
Stability: Frequency:	1 = ±50ppm 2 = ±25ppm 3 = ±20 ppm 5 = ±10 ppm xxx.xxxx = 1 MHz to 150 MHz (user-defined)	1.8V - 3.3V Low-Power Pre- cision CMOS Oscillator, 4- Lead 2.5 mm x 2.0 mm CDFN, Ext. Commercial Temperature Range, ±10 ppm, 150 MHz Output
Packing Option:	<pre><blank>= 110/Tube</blank></pre>	Frequency, 110/Tube d) DSC1004Al3-075.0000T:
	T = 1,000/Reel	1.8V - 3.3V Low-Power Precision CMOS Oscilla- tor, 4-Lead 7.0 mm x 5.0 mm DFN, Industrial Temperature Range, ±20 ppm, 75 MHz Output Frequency, 1,000/Reel
		Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

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